APPLICA	BLE STAN	DARD									
OPERATING		DE DANGE	STO		STORAGE			-10°C TO + 60°C (NOTE3)			
RATING	TEMPERATURE RANGE OPERATING		STOR		STORAGE			·			
RATING	HUMIDITY RANGE		APPI		HUMIDITY APPLICABI	MIDITY RANGE		40 % TO 70 % (NOTE			
	VOLTAGE		AC/DC 100V		CONNECTO			DF50#-40DS-			
CURRENT			AWG 28 : 1.0 A		APPLICAE CONTACT			DF50-2830S0			
			AWG 30 : 0.9 A AWG 32 : 0.7 A					DF50-3032SCFA			
			SPECI		TIONS	<u> </u>					
ļ	 ГЕМ	1	TEST METHOD		110110		PEOL	UREMENTS	Тат	AT	
	RUCTION		TEST WILTHOD				NEQU	III LIVILIA I I	Q1	1 🗥	
GENERAL EXAMINATION		VISUALLY AND BY MEASURING INSTRUMENT.			ACC	ACCORDING TO DRAWING.			X	X	
MARKING		CONFIRMED VISUALLY.				1				X	
	IC CHARA										
CONTACT F	RESISTANCE	AC 20mV MAX 1mA (DC OR 1000 Hz).			30mΩ	30mΩ MAX.				_	
INSULATION RESISTANCE		100V DC.			500Ms	500MΩ MIN.			X	<u> </u>	
VOLTAGE F		300V AC FOR 1 min.			NO FL	ASHOVE	R OR	BREAKDOWN.	X	<b> </b>	
MECHAN	VICAL CHA	I RACTI	ERISTICS		l				<u> </u>		
INSERTION	FORCE		BY APPLICABLE CONNECT	OR		INSERTION FORCE: 55.0 N MAX.					
WITHDRAW								CE: 5.3 N MIN.	X	_	
MECHANICAL OPERATION					2 N	<ol> <li>CONTACT RESISTANCE: 50mΩ MAX.</li> <li>NO DAMAGE, CRACK OR LOOSENESS</li> </ol>			X	_	
VIBRATION		FREQUE	NCY 10 TO 55 Hz, SINGLE A	MPLITUDE		OF PARTS.  ① NO ELECTRICAL DISCONTINUITY OF 1μs.				-	
	VIBICATION		0.75 mm, AT 10 CYCLE FOR EACH, FOR 3					RACK OR LOOSENESS	X	-	
SHOCK	CHOCK		DIRECTIONS.  490 m/s <sup>2</sup> DURATION OF PULSE 11 ms								
SHOOK		1	ES FOR 3 DIRECTIONS.	13							
ENVIRO	NMENTAL	CHAR	ACTERISTICS		I				-1		
DAMP HEAT		EXPOSED AT 40 ± 2 °C, 90 TO 95 %, 96 h.			-	① CONTACT RESISTANCE: 50mΩ MAX.			Х		
(STEADY S	(STEADY STATE)					② INSULATION RESISTANCE: 100MΩ MIN. ③ NO DAMAGE, CRACK OR LOOSENESS OF PARTS.				_	
RAPID CHA		TEMPERATURE -55→+85°C				① CONTACT RESISTANCE: $50m\Omega$ MAX.					
TEMPERATURE		TIME 30→ 30min. UNDER 5 CYCLES. THE TRANSFERRING TIME OF THE TANK IS 2~3 min.			3 N	② INSULATION RESISTANCE: 500MΩ MIN. ③ NO DAMAGE, CRACK OR LOOSENESS OF PARTS.				_	
		ESCRIPTION	SCRIPTION OF REVISIONS DESIG			SNED CHECKED			D	ATE	
						APPRO	WED.	NI TAINT	10	06.00	
								KI. AKIYAMA	+	06.08	
						CHECKED		HK. UMEHARA TT. OHSAKO		12. 06. 08 12. 06. 08	
						DESIGNED				06. 08	
Note OT:Qualification Test AT:Assurance Test V:Applicable Test					FI 04 004				JU. UO		
Note QT:Qualification Test AT:Assurance Test X:Applicable Test  SPECIFICATION SHEET				ART NO.	7557 4257 4445						
OL	11/				ODE NO.				<u>/</u>	1/2	
EODM HD0011 2 1			CODE		ODE NO.	_ NO.   OLUGO GOOD 9 02				_''^	

SPECIFICATIONS							
ITEM	TEST METHOD	REQUIREMENTS	QT	АТ			
SOLDERABILITY	SOLDERED AT SOLDER TEMPERATURE, 245°C FOR INSERTION DURATION, 5 sec.	SOLDER SHALL COVER A MINIMUM OF 95 % OF THE SURFACE BEING IMMERSED.	х	_			
RESISTANCE TO SOLDERING HEAT	1) REFLOW SOLDERING  «REFLOW AREA»  MAX250°C WITHIN 10 sec  MIN 220°C WITHIN 60 sec  «PREHEATING AREA»  150~180°C 90~120s  2) MANUAL SOLDERING  SOLDERING IPON TEMPERRATURE 350±10°C  SOLDERING TIME 3~4s.  NO STRENGTH ON CONTACT.	NO DEFORMATION OF CASE OF EXCESSIVE LOOSENESS OF THE TERMINALS.	X	-			

## REMARKS

NOTE 1: INCLUDING THE TEMPERATURE RISE BY CURRENT.

NOTE 2: NON-CONDENSING

NOTE 3: APPLY TO THE CONDITION OF LONG TERM STORAGE FOR UNUSED PRODUCTS BEFORE PCB ON BOARD.

AFTER PCB BOARD, OPERATING TEMPERATURE AND HUMIDITY RANGE IS APPLIED FOR INTERIM STORAGE DURING TRANSPORTATION

Unless otherwise specifid , refer to JIS C 5402.

Note QT:Q	tualification Test AT:Assurance Test X:Applicable Test	DRAWIN	IG NO.	ELC4-324909-02		
HRS	SPECIFICATION SHEET	PART NO.	ART NO. DF50-40DP-1V (52)			
	HIROSE ELECTRIC CO., LTD.	CODE NO	CL665	5-0005-9-52	$\Delta$	2/2